Series LHP-150 TO-247

150 W Thick Film Resistor for high-frequency and pulse-loading applications



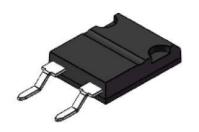
A Miba Group Company

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EBG Resistor offers the completely encapsulated and insulated TO-247 package for low ohmic value and Non-Inductive design for high-frequency and pulse-loading applications. Ideal use for power supplies. The LHP-150 series is rated at 150 W mounted to a heat sink.

Features

- 150 W operating power
- TO-247 package configuration
- Resistor package completely insulated from heat sink
- Non-Inductive design



Technical Specifications

Resistance value	$0.2~\Omega \le 1~M\Omega$
Resistance tolerance	$\pm 5~\%$ to $\pm 10~\%$ $\pm 0.5~\%$ on special request for limited ohmic values
Temperature coefficient	±150 ppm/°C (+25°C to +105°C, ref. to +25°C)
Power rating	150 W at 25°C bottom case temperature
Maximum operating voltage	700 V DC
Dielectric strength	1800 V AC
Insulation resistance	min. 10 G Ω
Momentary overload	2 times rated power, but no more than 1.5 time max. continuous operating voltage, last 5s, $\Delta R \le \pm (0.5\% R + 0.001\Omega)$
Load life	2,000 hours at rated power, MIL-R-39009D $\Delta R \leq \pm (1.0\%R+0.001\Omega)$
Moisture resistance	MIL-Std202, method 106, $\Delta R \le \pm (0.5\% R + 0.001\Omega)$
Thermal schock	MIL-Std202, method 107, Cond. F $\Delta R \le \pm (0.3\% R + 0.001\Omega)$
Terminal strength	MIL-Std202, method 211, Cond. A (pull test) $2.4~N~\Delta R \le \pm (0.2\%~R + 0.001\Omega)$
Vibration, high frequency	MIL-Std202, method 204, Cond. D $\Delta R \le \pm (0.2\% R + 0.001\Omega)$
Working temperature	-55°C to +175°C
Lead material	tinned copper
Weight	~4.2 g

60 40 20

Derating (thermal resist.) LHP-150: 1.00 W/K (1.0 K/W)

Without a heat sink, when in open air at 45°C, the LHP-150 is rated for 4.5 W.

How to make an order

LHP-150_Ohmic Value_Tolerance

For example:

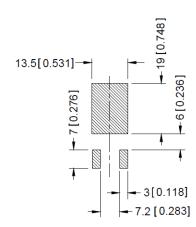
LHP-150 50R 5%

Application Standard

- IEC60115-1: 2001 (GB/T5729-2003)
- MIL-STD-202
- MIL-R-39009D
- AEC-Q200

Soldering Note:

During surface mount soldering, the soldering temp. profile **must not** cause the metal tab of this device to **exceed 245°C**.



Dimensions in mm [inches]

